

Special Issue

Advanced Thermal Analysis and Techniques in High-Fat Food Products

Message from the Guest Editor

The quality of fat in food products determines its suitability for consumption. Fat is a food component that goes rancid relatively quickly, mainly to its sensitivity to high temperature, high humidity and light radiation. High-fat food products include a wide range of varied products, such as chocolate or canned meat. A very important aspect in food analysis is the study of fats in products using thermal techniques. Using these techniques, it is possible to research not only the fat itself but also the products that contain it. Thermal techniques are dynamically developing research methods, including DSC, PDSC, DTMA, TGA and many others.

Guest Editor

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